

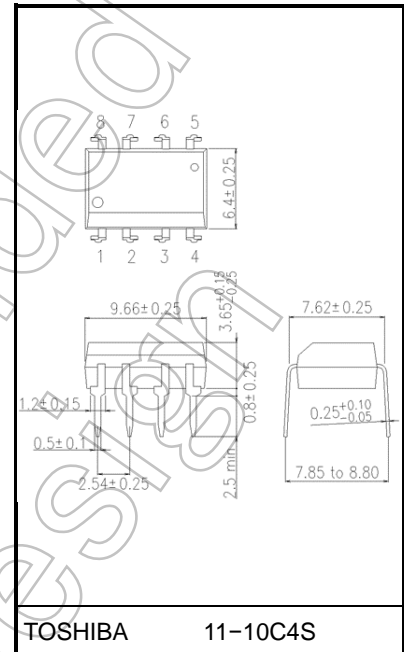
# 6N138, 6N139

Current Loop Driver  
Low Input Current Line Receiver  
CMOS Logic Interface

The TOSHIBA 6N138 and 6N139 consists of an infrared emitting diode coupled with a split-Darlington output configuration. A high speed Ired manufactured with an unique LPE junction, has the virtue of fast rise and fall time at low drive current.

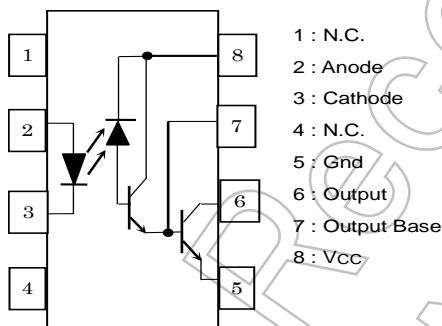
- Isolation voltage: 2500 Vrms (min)
- Current transfer ratio
  - : 6N138 – 300% (min) (IF=1.6mA)
  - : 6N139 – 400% (min) (IF=0.5mA)
- Switching time: 6N138
  - tPHL = 10μs (max)
  - tPLH = 35μs (max)
 6N139
  - tPHL = 1μs (max)
  - tPLH = 7μs (max)
- UL-recognized: UL 1577, File No.E67349

Unit: mm

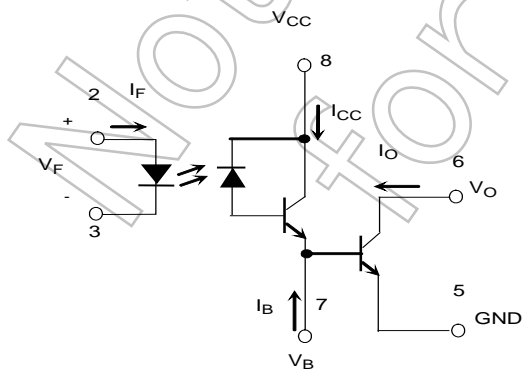


Weight: 0.54 g (typ.)

## Pin Configuration (top view)



## Schematic



Start of commercial production  
1988-02

### Absolute Maximum Ratings (\*) (Ta = 0°C to + 70°C)

Characteristics		Symbol	Rating	Unit
LED	Forward current (Note 1)	I <sub>F</sub>	20	mA
	Pulse forward current	I <sub>FP</sub> <sup>(*)</sup>	40	mA
	Total pulse forward current	I <sub>FP</sub> <sup>(*)</sup>	1	A
	Reverse voltage	V <sub>R</sub>	5	V
	Diode power dissipation (Note 2)	P <sub>D</sub>	35	mW
Detector	Output current (Note 3)	I <sub>O</sub>	60	mA
	Emitter–base reverse voltage	V <sub>EB</sub>	0.5	V
	Supply voltage	V <sub>CC</sub> <sup>(*)</sup>	–0.5 to 18	V
	Output voltage	V <sub>O</sub> <sup>(*)</sup>	–0.5 to 18	V
	Output power dissipation (Note 4)	P <sub>O</sub>	100	mW
Operating temperature range		T <sub>opr</sub>	0 to 70	°C
Storage temperature range		T <sub>stg</sub>	–55 to 125	°C
Lead solder temperature (10s) <sup>(*)</sup>		T <sub>sol</sub>	260	°C
Isolation voltage (60s, R.H.≤ 60%)		BV <sub>S</sub> <sup>(**)</sup>	2500	V <sub>rms</sub>
			3540	V <sub>dc</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

(\*) JEDEC registered data

(\*\*) Not registered JEDEC

(\*) 50 % duty cycle, 1 ms pulse width

(\*) Pulse width 1 μs, 300 pps

(\*) 6N138... –0.5 to 7 V

(\*) 1.6 mm below seating plane

### Electrical Characteristics

Over Recommended Temperature ( $T_a = 0^\circ\text{C}$  to  $70^\circ\text{C}$ , unless otherwise noted)

Characteristics		Symbol	Test Condition	Min	(*5)Typ.	Max	Unit
Current transfer ratio (Note 5, 6)	6N139	CTR(*)	$I_F = 0.5\text{ mA}$ , $V_O = 0.4\text{ V}$ $V_{CC} = 4.5\text{ V}$	400	800	—	%
	6N138		$I_F = 1.6\text{ mA}$ , $V_O = 0.4\text{ V}$ $V_{CC} = 4.5\text{ V}$	500	900	—	
					300	600	
Logic low output voltage (Note 6)	6N139	$V_{OL}$	$I_F = 1.6\text{ mA}$ , $I_O = 6.4\text{ mA}$ $V_{CC} = 4.5\text{ V}$	—	0.1	0.4	V
			$I_F = 5\text{ mA}$ , $I_O = 15\text{ mA}$ $V_{CC} = 4.5\text{ V}$	—	0.1	0.4	
			$I_F = 12\text{ mA}$ , $I_O = 24\text{ mA}$ $V_{CC} = 4.5\text{ V}$	—	0.2	0.4	
	6N138		$I_F = 1.6\text{ mA}$ , $I_O = 4.8\text{ mA}$ $V_{CC} = 4.5\text{ V}$	—	0.1	0.4	
Logic high output current (Note 6)	6N139	$I_{OH}(*)$	$I_F = 0\text{ mA}$ , $V_O = V_{CC} = 18\text{ V}$	—	0.05	100	$\mu\text{A}$
	6N138		$I_F = 0\text{ mA}$ , $V_O = V_{CC} = 7\text{ V}$	—	0.05	250	
Logic low supply current (Note 6)		$I_{CCL}$	$I_F = 1.6\text{ mA}$ , $V_O = \text{Open}$ $V_{CC} = 5\text{ V}$	—	0.2	—	mA
Logic high supply current (Note 6)		$I_{CCH}$	$I_F = 0\text{ mA}$ , $V_O = \text{Open}$ , $V_{CC} = 5\text{ V}$	—	10	—	nA
Input forward voltage		$V_F(*)$	$I_F = 1.6\text{ mA}$ , $T_a = 25\text{ }^\circ\text{C}$	—	1.65	1.7	V
Input reverse breakdown voltage		$BV_R(*)$	$I_R = 10\text{ }\mu\text{A}$ , $T_a = 25\text{ }^\circ\text{C}$	5	—	—	V
Temperature coefficient of forward voltage		$\Delta V_F / \Delta T_a$	$I_F = 1.6\text{ mA}$	—	−1.9	—	mV / $^\circ\text{C}$
Input capacitance		$C_{IN}$	$f = 1\text{ MHz}$ , $V_F = 0\text{ V}$	—	60	—	pF
Resistance (input–output)		$R_{I-O}$	$V_{I-O} = 500\text{ V}$ (Note 7), $R.H. \leq 60\%$	—	$10^{12}$	—	$\Omega$
Capacitance (input–output)		$C_{I-O}$	$f = 1\text{ MHz}$ , $V = 0\text{ V}$ (Note 7)	—	0.6	—	pF

(\*\*) JEDEC registered data.

(\*5) All typical values are at  $T_a = 25^\circ\text{C}$  and  $V_{CC} = 5\text{ V}$ , unless otherwise noted.

## Switching Specifications (Ta=25°C, Vcc=5V, unless otherwise specified)

Characteristics		Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Propagation delay time to logic low at output (Note 6, 8)	6N139	t <sub>pHL</sub> (*)	1	I <sub>F</sub> = 0.5 mA, R <sub>L</sub> = 4.7 kΩ	—	5	25	μs
				I <sub>F</sub> = 12 mA, R <sub>L</sub> = 270 Ω	—	0.2	1	
	6N138			I <sub>F</sub> = 1.6 mA, R <sub>L</sub> = 2.2 kΩ	—	1	10	
Propagation delay time to logic high at output (Note 6, 8)	6N139	t <sub>pLH</sub> (*)	1	I <sub>F</sub> = 0.5 mA, R <sub>L</sub> = 4.7 kΩ	—	5	60	μs
				I <sub>F</sub> = 12 mA, R <sub>L</sub> = 270 Ω	—	1	7	
	6N138			I <sub>F</sub> = 1.6 mA, R <sub>L</sub> = 2.2 kΩ	—	4	35	
Common mode transient immunity at logic high level output (Note 9)		CM <sub>H</sub>	2	I <sub>F</sub> = 0 mA, R <sub>L</sub> = 2.2 kΩ V <sub>CM</sub> = 400 V <sub>p-p</sub>	—	500	—	V / μs
Common mode transient immunity at logic low level output (Note 9)		CM <sub>L</sub>	2	I <sub>F</sub> = 1.6 mA R <sub>L</sub> = 2.2 kΩ V <sub>CM</sub> = 400 V <sub>p-p</sub>	—	–500	—	V / μs

(\*)JEDEC registered data.

(Note 1): Derate linearly above 50 °C free-air temperature at a rate of 0.4 mA / °C

(Note 2): Derate linearly above 50 °C free-air temperature at a rate of 0.7 mW / °C

(Note 3): Derate linearly above 25 °C free-air temperature at a rate of 0.7 mA / °C

(Note 4): Derate linearly above 25 °C free-air temperature at a rate of 2.0 mW / °C

(Note 5): DC CURRENT TRANSFER RATIO is defined as the ratio of output collector current,  $I_O$ , to the forward LED input current,  $I_F$ , times 100 %.

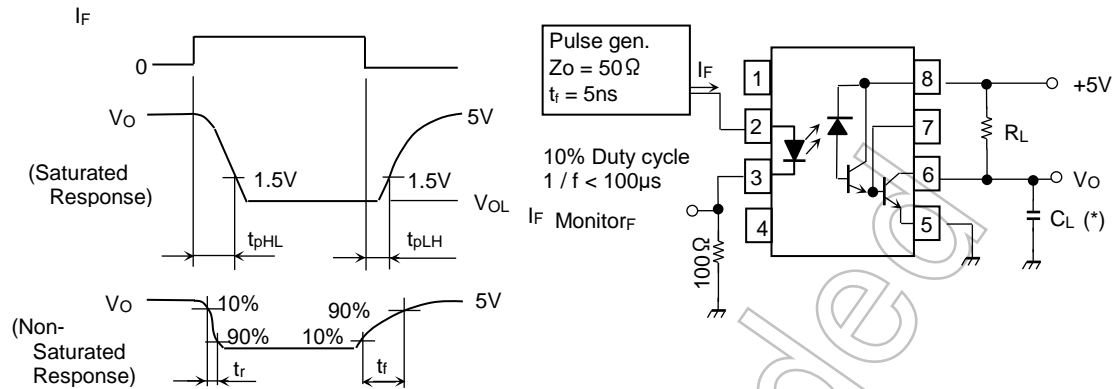
(Note 6): Pin 7 open.

(Note 7): Device considered a two-terminal device: Pins 1, 2, 3, and 4 shorted together and Pins 5, 6, 7 and 8 shorted together.

(Note 8): Use of a resistor between pin 5 and 7 will decrease gain and delay time.

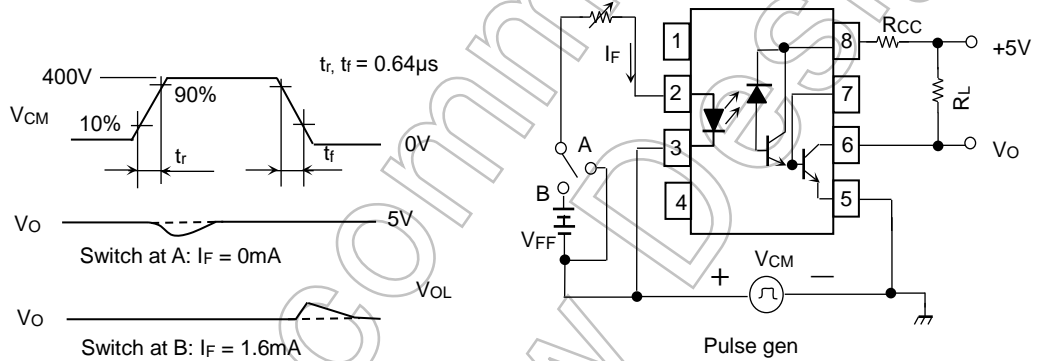
(Note 9): Common mode transient immunity in logic high level is the maximum tolerable (positive)  $dV_{CM} / dt$  on the leading edge of the common mode pulse,  $V_{CM}$ , to assure that the output will remain in a logic high state (i.e.  $V_O > 2.0 \text{ V}$ ).  
Common mode transient immunity in Logic Low level is the maximum tolerable (negative)  $dV_{CM} / dt$  on the trailing edge of the common mode pulse signal,  $V_{CM}$ , to assure that the output will remain in a logic low state (i.e.  $V_O < 0.8 \text{ V}$ ).

### Test Circuit 1.



(\*)  $C_L$  is approximately 15pF which includes probe and stray wiring capacitance.

### Test Circuit 2.



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